**Advanced Information** 

# Frequency Generator for Modem Systems

## **General Description**

The ICS9117-02 is a low-cost, high-performance frequency generator designed to support fax/data modem systems. Data-pump and UART clocks are synthesized from a microcontroller crystal using high-accuracy, low-jitter PLLs, meeting the frequency tolerance and -96dB signalto-noise ratios required by 16-bit DSP modem systems. Fast output clock edge rates minimize board induced jitter.

Integrated

Systems, Inc.

Circuit

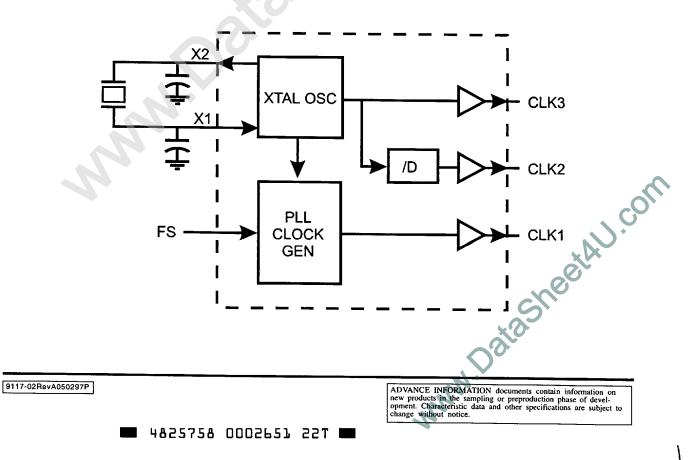
Exact frequency multiplying ratios ensure better than  $\pm 80$  ppm frequency accuracy using a standard low cost crystal with external load capacitors (typically  $33pF\pm5\%$  for an 18pF series load crystal). Achieving  $\pm 80$  ppm over four years requires the crystal to have  $\pm 20$  ppm initial accuracy,  $\pm 20$  ppm temperature and  $\pm 5$  ppm/year aging coefficients.

#### Features

- Generates the 35.2512 MHz microcontroller, 40.320 MHz datapump and selectable microcontroller clocks plus the UART clock.
- Less than ±80 ppm frequency variation including temperature, voltage, load and aging tolerances
- Single crystal reference minimizes crystal reliability and inventory issues
- 100 ps one sigma jitter maintains 16-bit performance
- Output rise/fall times less than 1.5ns
- · On-chip loop filter components
- 3.0V or 5.5V operation
- 8-pin, 150-mil SOIC package

#### **Applications**

 Specifically designed to support the highperformance of fax/data modem and WLAN systems.

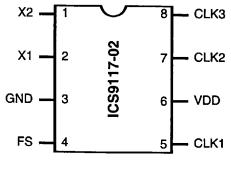


#### **Block Diagram**

#### **Advanced Information**



# **Pin Configuration**



**8-PIN SOIC** 

# Functionality

X1, X2 (MHz)	FS	CLK3 (MHz)	CLK1 (MHz)	CLK2 (MHz)	
22.1184	0	22.1184	35.2512	1.8432	
44.4000	1	44.4000	40.320	1.8500	

# **Pin Descriptions**

PIN NUMBER	PIN NAME	TYPE	DESCRIPTION
1	X2	OUT	22.1 or 44.4 MHz crystal drive output.
2	X1	IN	22.1 or 44.4 MHz crystal or clock input.
3	GND	PWR	Power Gnd
4	FS	IN	Frequency selection inut (see frequency table).
5	CLK1	OUT	datapump clock output.
6	VDD	PWR	+5V or +3.3V power supply.
7	CLK2	OUT	UART clock output.
8	CLK3	OUT	Microcontroller clock output.



#### **Advanced Information**

### Absolute Maximum Ratings

AV <sub>DD</sub> , V <sub>DD</sub> referenced to GND	·7V
Operating temperature under bias	0 ℃ to +70 ℃
Storage temperature	
Voltage on I/O pins referenced to GND	$GND - 0.5V$ to $V_{DD} + 0.5V$
Power dissipation	0.5 Watts

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

### **Electrical Characteristics at 3.3V**

Operating $V_{DD}$ = +3.0 V to +3.7V; $T_A$ =	0 °C to 70°C unless otherwise stated
---	--------------------------------------

DC Characteristics						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Input Low Voltage	VIL		-	•	0.8	v
Input High Voltage	VIH		2.0	-	-	v
Input Low Current	IIL	V <sub>IN</sub> =0V	-	7.0	-25.0	μA
Input High Current	Ін	V <sub>IN</sub> =V <sub>DD</sub>	-	-	5.0	μA
Output Low Voltage	Vol*	$I_{\alpha} = +10 \text{mA}$	-	0.15	0.4	V
Output High Voltage	VOH*	I <sub>ot</sub> =-10mA	2.4	3.7		v
Output Low Current	IOL*	V=0.8V	20.0	35.0	-	mA
Output High Current	Іон*	V=2.4V	-	-20.0	-10.0	mA
Supply Current	Icc	Unloaded	-	14.0	30.0	mA
Pull-up Resistor Value	Rpu*		-	400.0	800.0	k ohm
		AC Characteristics				- K OIIII
Rise Time	Tr*	150/f kiadm 0.8 to 2.0V		1.2	2.0	ns
Fall Time	Tf*	15pF load, 2.0 to 0.8V		1.0	1.5	ns
Lock Time	TL*	15pF load, 20%to 80%		·····	0	ms
Duty Cycle	Dt*	15pFload @50% of VDD; Except REFCLK	45	50	55	%
Duty Cycle	Dı*	15pF load@50% of VDD; Except REFCLK only	45	50	55	%
Jitter, One Sigmea	Tjis*	For all frequencies except REFCLK		70	100	ps
Jitter, Absolute	Tjab*	Forall frequencies except REFCLK	-300		+300	ps
Jitter, One Sigma	Tjis*	REFCLK only		200	300	ps
Jitter, Absolute	Tjab*	REFCLK only	-500		+500	ps ps
Input FrequencyRange	Fi*		4		28	MHz
Output Frequency Range	Fo*		11.7		+4	MHz
OutputMean Frequency Accuracy vs.Target	Foa*	With 14.318 MHzinput	-30		+80	ppm
Power-up Time	Tpu*	0 to 33.8 MHz		2.5	4.5	ms
Crystal Input Capacitance	C <sup>inx</sup> *	X1 (Pin 1) X2 (Pin 8)		18		pF

\* Parameter is guaranteed by design and characterization. Not 100% tested in production.

#### **Advanced Information**



#### **Absolute Maximum Ratings**

AV <sub>DD</sub> , V <sub>DD</sub> referenced to GND	7V
Operating temperature under bias	0 °C to +70 °C
Storage temperature	65 °C to +150 °C
Voltage on I/O pins referenced to GND	GND - 0.5 V to $V_{DD}$ + 0.5 V
Power dissipation	0.5 Watts

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

#### **Electrical Characteristics at 5.0V-5.5V**

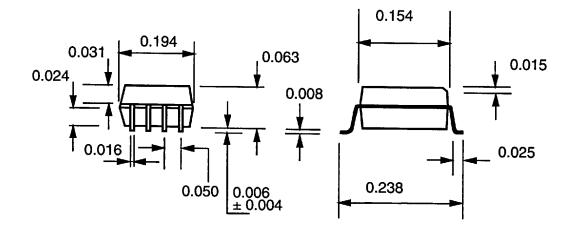
		DC Characteristics				<u> </u>	
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS	
Input Low Voltage	V <sub>IL</sub>		-	-	0.8	v	
Input High Voltage	V <sub>IH</sub>		2.0	-	-	v	
Input Low Current	I <sub>IL</sub>	V <sub>IN</sub> =0V	-	-4.0	-25	μA	
Input High Current	I <sub>IH</sub>	V <sub>IN</sub> =V <sub>DD</sub>	-	-	5.0	μA	
Output Low Voltage	V <sub>OL</sub> *	I <sub>0L</sub> =+10mA	-	0.15	0.4	V	
Output High Voltage	V <sub>OH</sub> *	I <sub>OH</sub> =-15mA	4.0	4.2	-	v	
Output Low Current	Iat*	V=0.8V	25.0	40.0	-	mA	
Output High Current	I <sub>OH</sub> *	V=2.4V	-	-85.0	-65	mA	
Supply Current	I <sub>CC</sub>	Unloaded	-	20.0	-35	mA	
Pull-up Resistor Value	R <sub>pu</sub> *		-	400.0	800.0	k ohm	
AC Characteristics							
Rise Time	T <sub>r</sub> *	150/f kiadm 0.8 to 2.0V		0.8	1.5	ns	
Fall Time	T <sub>f</sub> *	15pF load, 2.0 to 0.8V		1.0	25	ns	
Lock Time	T <sub>L</sub> *	15pF load, 20%to 80%			10	ms	
Duty Cycle	D <sub>t</sub> *	15pFload @50% of VDD; Except REFCLK	45	50	55	%	
Duty Cycle	D <sub>t</sub> *	15pF load@50% of VDD; Except REFCLK only	45	50	55	%	
Jitter, One Sigmea	T <sub>jis</sub> *	For all frequencies except REFCLK		80	100	ps	
Jitter, Absolute	T <sub>jab</sub> *	Forall frequencies except REFCLK	-300		+300	ps	
Jitter, One Sigma	T <sub>jis</sub> *	REFCLK only		200	250	ps	
Jitter, Absolute	T <sub>iab</sub> *	REFCLK only	-500		+500	ps	
Input FrequencyRange	F <sub>i</sub> *		5		4.3	MHz	
Output Frequency Range	F <sub>o</sub> *		14		114	MHz	
OutputMean Frequency Accuracy vs.Target	F <sub>oa</sub> *	With 14.318 MHzinput	-80		+80	ppm	
Power-up Time	T <sub>pu</sub> *	0 to 33.8 MHz		2.5	4.5	ms	
Crystal Input Capacitance	C <sup>inx</sup> *	X1 (Pin 1) X2 (Pin 8)		18		pF	

Operating  $V_{DD}$  = +3.0 V to +3.7V;  $T_A$  = 0 °C to 70°C unless otherwise stated

\* Parameter is guaranteed by design and characterization. Not 100% tested in production.



#### **Advanced Information**

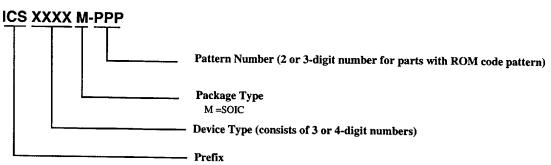


8-Pin SOIC

## **Ordering Information**



Example:



5

ICS, AV=Standard Device

ADVANCE INFORMATION documents contain information on new products in the sampling or preproduction phase of development. Characteristic data and other specifications are subject to change without notice.

4825758 0002655 975 🔳